



To the Honorable Commissioner of Patents

inal documents or copies thereof.

1. Name of conveying party(ies):

Daniel L. Bouvier

10-16-07

Additional name(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: Applied Micro Circuits Corporation

Internal Address: _____

Street Address: 6290 Sequence Drive

City, State and ZIP: San Diego, CA 92121

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: 10/12/2007

4. Application number(s) or registration number(s):

If this document is being filed together with a new application, the execution date of the application is:

10/16/2007

A. Patent Application No.(s)

10/18/2007 SSITHIB1 00000016 11974729

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40.00 OP

Additional numbers attached? Yes No

B. Patent No.(s)

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Gerald W. Maliszewski

Internal Address: Registration No. 38,054

Street Address: P.O. Box 270829

City, State and ZIP: San Diego, CA 92198-2829

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) \$ 40.00

Enclosed - Any excess or insufficiency should be credited or debited to deposit account

Authorized to be charged to deposit account

8. Deposit Account number:

502033

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Gerald W. Maliszewski, Reg. # 38,054

Name of Person Signing

Signature

10/15/2007

Date

Total number of pages including cover sheet, attachments, and document: 4

ASSIGNMENT

WHEREAS, the undersigned Daniel L. Bouvier, resident of Austin, TX, (hereinafter termed "inventor") has invented certain new and useful improvements in:

CHANNEL-LESS MULTITHREADED DMA CONTROLLER

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

On the 12TH day of October, 2007;

Or

Said application having been previously filed and assigned Serial Number / _____, and filing date _____.

WHEREAS Applied Micro Circuits Corporation (AMCC), a corporation (hereinafter termed "Assignee"), having a place of business at 6290 Sequence Drive, San Diego, CA, 92121, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any and all countries of the world for patents, certificates of inventions or other government grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other

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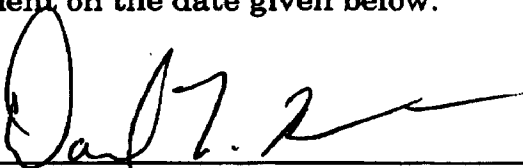
applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said inventor shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting application for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, said Inventor's heirs, legal representatives and assigns.

4. Said Inventor hereby warrants and represents that said Inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventor has executed said Assignment on the date given below.

(1) 
(Daniel L. Bouvier, Signature)

10/12/2007
(Date)

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